

Fast IGBT in NPT-technology

- 75% lower $E_{
 m off}$ compared to previous generation combined with low conduction losses
- Short circuit withstand time 10 μs
- Designed for:
 - Motor controls
 - Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC² for target applications
- Complete product spectrum and PSpice Models: http://www.infineon.com/igbt/







Туре	V _{CE}	I c	V _{CE(sat)150°C}	T j	Marking	Package
SGP06N60	600V	6A	2.3V	150°C	G06N60	PG-TO-220-3-1
SGD06N60	600V	6A	2.3V	150°C	G06N60	PG-TO-252-3-11

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current	I _C		Α
$T_{\rm C}$ = 25°C		12	
$T_{\rm C}$ = 100°C		6.9	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	24	
Turn off safe operating area	-	24	
$V_{\text{CE}} \le 600 \text{V}, \ T_{\text{j}} \le 150^{\circ} \text{C}$			
Gate-emitter voltage	V _{GE}	±20	V
Avalanche energy, single pulse	E _{AS}	34	mJ
$I_{\rm C}$ = 6 A, $V_{\rm CC}$ = 50 V, $R_{\rm GE}$ = 25 Ω ,			
start at $T_j = 25^{\circ}\text{C}$			
Short circuit withstand time ¹⁾	tsc	10	μs
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le 600$ V, $T_{\rm j} \le 150$ °C			
Power dissipation	P _{tot}	68	W
$T_{\rm C}$ = 25°C			
Operating junction and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55+150	°C
Soldering temperature, PG-TO-252: (reflow soldering, MSL1) Others: wavesoldering, 1.6mm (0.063 in.) from case for 10s	T _s	260 260	

² J-STD-020 and JESD-022

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



SGP06N60 SGD06N60

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	1			1
IGBT thermal resistance,	R _{thJC}		1.85	K/W
junction – case				
Thermal resistance,	R_{thJA}	PG-TO-220-3-1	62	
junction – ambient				
SMD version, device on PCB ¹⁾	R _{thJA}	PG-TO-252-3-1	50	

Electrical Characteristic, at $T_{\rm j}$ = 25 °C, unless otherwise specified

Doromotor	Cymbol	Conditions		Value		Unit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\rm GE} = 0 \text{V}, I_{\rm C} = 500 \mu \text{A}$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 \rm V, I_{\rm C} = 6 \rm A$				
		<i>T</i> _j =25°C	1.7	2.0	2.4	
		T _j =150°C	-	2.3	2.8	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 250 \mu A, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μΑ
		<i>T</i> _j =25°C	-	-	20	
		T _j =150°C	-	-	700	
Gate-emitter leakage current	I _{GES}	V _{CE} =0V, V _{GE} =20V	-	-	100	nA
Transconductance	g _{fs}	V _{CE} =20V, I _C =6A	-	4.2	-	S
Dynamic Characteristic					,	
Input capacitance	Ciss	V _{CE} =25V,	-	350	420	pF
Output capacitance	Coss	$V_{GE}=0V$,	-	38	46	
Reverse transfer capacitance	Crss	<i>f</i> =1MHz	1	23	28	
Gate charge	Q _{Gate}	$V_{\rm CC}$ =480V, $I_{\rm C}$ =6A	-	32	42	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 10 \mu \text{s}$ $V_{\text{CC}} \le 600 \text{V},$ $T_{\text{j}} \le 150 ^{\circ} \text{C}$	-	60	-	A

 $^{^{1)}}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for collector connection. PCB is vertical without blown air. $^{2)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



SGP06N60 SGD06N60

Switching Characteristic, Inductive Load, at $\textit{T}_{j}\text{=}25~^{\circ}\text{C}$

Parameter	Symbol	Conditions		Value		Unit
raiailletei	Symbol	Conditions	min.	typ.	max.	Oilit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_j = 25^{\circ}\text{C}$	-	25	30	ns
Rise time	t _r	$V_{CC} = 400 \text{V}, I_{C} = 6 \text{A},$ $V_{GF} = 0/15 \text{V},$	-	18	22	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =50 Ω ,	-	220	264	
Fall time	t_{f}	$L_{\sigma}^{(1)} = 180 \text{ nH},$	-	54	65	
Turn-on energy	Eon	$C_{\sigma}^{1)}$ =250pF Energy losses include	ı	0.110	0.127	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.105	0.137	
Total switching energy	E _{ts}	reverse recovery.	1	0.215	0.263	

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Cumbal	Conditions		Value		l lmi4
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T _j =150°C	-	24	29	ns
Rise time	tr	V_{CC} =400V, I_{C} =6A, V_{GE} =0/15V,	-	17	20	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =50 Ω ,	-	248	298	
Fall time	tf	$L_{\sigma}^{(1)} = 180 \text{ nH},$	-	70	84	
Turn-on energy	Eon	$C_{\sigma}^{1)}$ =250pF Energy losses include	-	0.167	0.192	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.153	0.199	
Total switching energy	E _{ts}	reverse recovery.	-	0.320	0.391	

 $^{^{1)}}$ Leakage inductance L $_{\sigma}$ and Stray capacity C $_{\sigma}$ due to dynamic test circuit in Figure E.





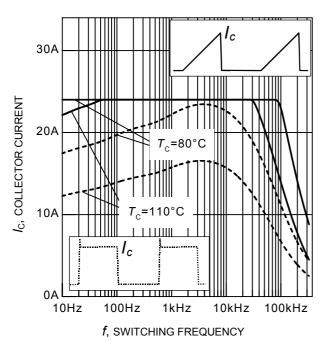
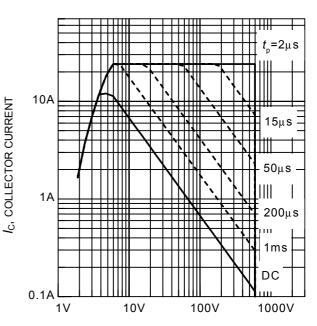


Figure 1. Collector current as a function of switching frequency

 $(T_{\rm j} \le 150^{\circ}{\rm C}, D = 0.5, V_{\rm CE} = 400{\rm V}, V_{\rm GE} = 0/+15{\rm V}, R_{\rm G} = 50\Omega)$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}C, T_i \le 150^{\circ}C)$

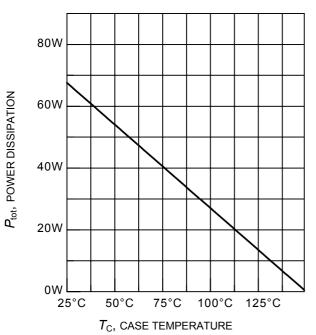


Figure 3. Power dissipation as a function of case temperature

 $(T_i \le 150^{\circ}C)$

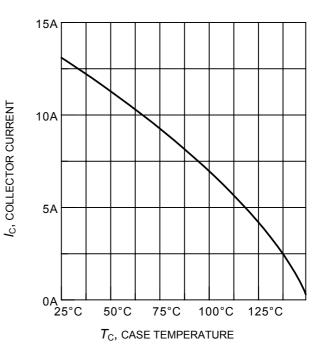


Figure 4. Collector current as a function of case temperature

 $(V_{GE} \le 15V, T_i \le 150^{\circ}C)$



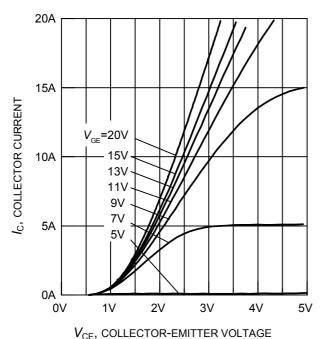


Figure 5. Typical output characteristics $(T_i = 25^{\circ}C)$

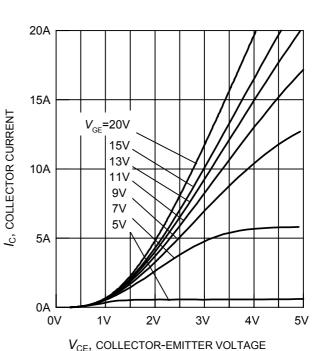


Figure 6. Typical output characteristics $(T_i = 150^{\circ}\text{C})$

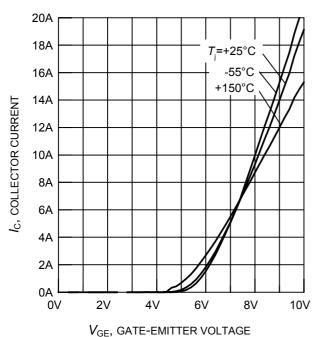


Figure 7. Typical transfer characteristics ($V_{CE} = 10V$)

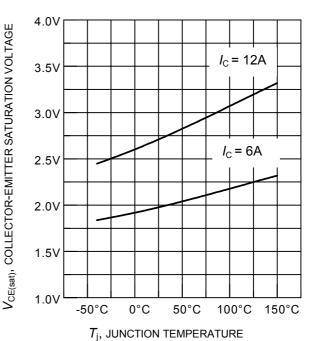
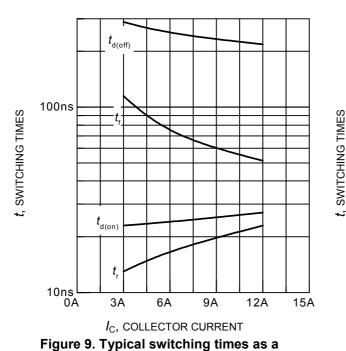


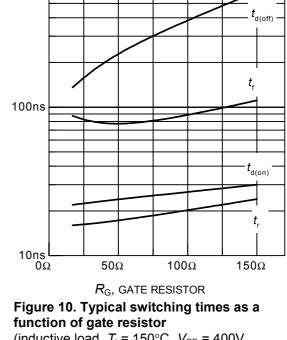
Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature ($V_{\rm GE} = 15 \rm V$)







function of collector current (inductive load, $T_j = 150^{\circ}\text{C}$, $V_{\text{CE}} = 400\text{V}$, $V_{\text{GE}} = 0/+15\text{V}$, $R_{\text{G}} = 50\Omega$, Dynamic test circuit in Figure E)



function of gate resistor (inductive load, T_j = 150°C, V_{CE} = 400V, V_{GE} = 0/+15V, I_C = 6A, Dynamic test circuit in Figure E)

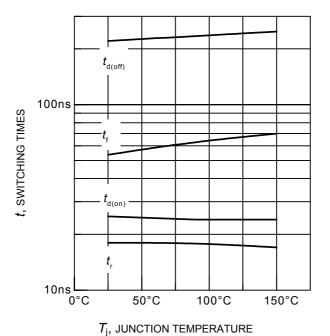


Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 6A, $R_{\rm G}$ = 50 Ω , Dynamic test circuit in Figure E)

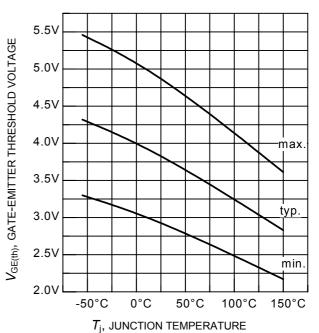


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ($I_C = 0.25 \text{mA}$)



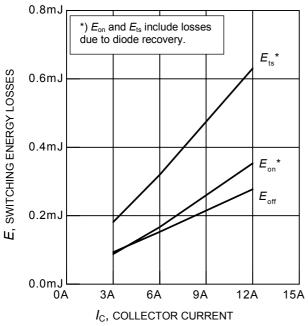


Figure 13. Typical switching energy losses as a function of collector current (inductive load, T_j = 150°C, V_{CE} = 400V, V_{GE} = 0/+15V, R_G = 50 Ω , Dynamic test circuit in Figure E)

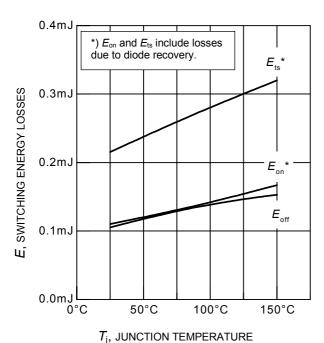


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, $V_{\text{CE}} = 400\text{V}$, $V_{\text{GE}} = 0/+15\text{V}$, $I_{\text{C}} = 6\text{A}$, $R_{\text{G}} = 50\Omega$, Dynamic test circuit in Figure E)

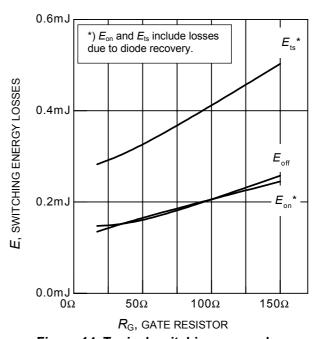


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_j = 150^{\circ}\text{C}$, $V_{\text{CE}} = 400\text{V}$, $V_{\text{GE}} = 0/+15\text{V}$, $I_{\text{C}} = 6\text{A}$, Dynamic test circuit in Figure E)

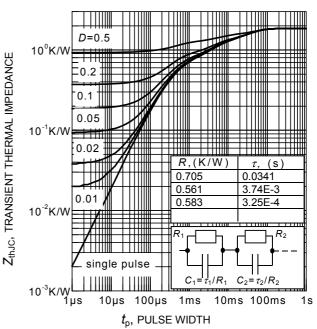
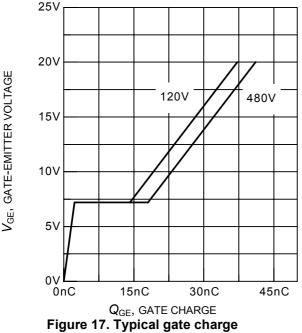


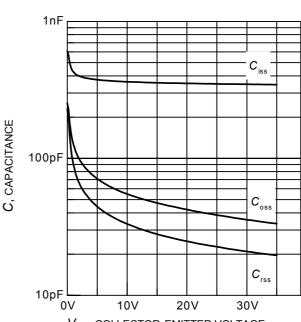
Figure 16. IGBT transient thermal impedance as a function of pulse width $(D = t_p / T)$







 $(I_{\rm C} = 6A)$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE} = 0V, f = 1MHz)$

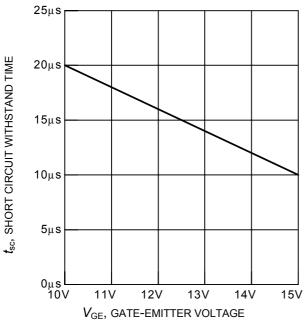
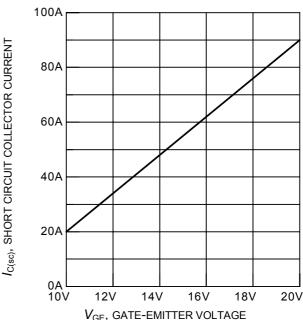


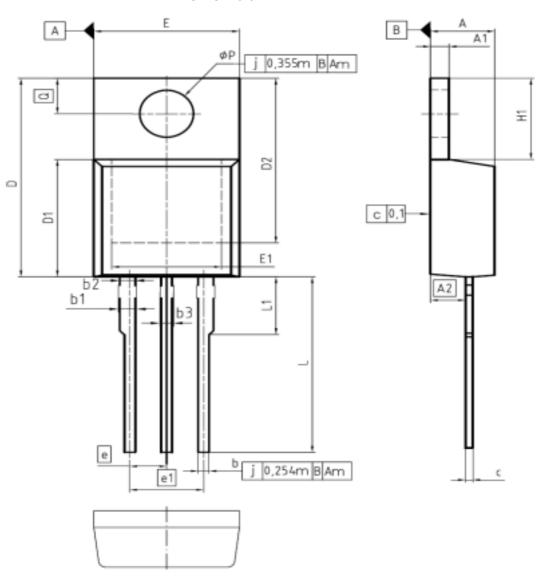
Figure 19. Short circuit withstand time as a function of gate-emitter voltage $(V_{CE} = 600 \text{V}, \text{ start at } T_i = 25^{\circ}\text{C})$



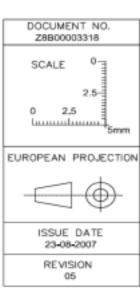
 $V_{\mathrm{GE}},\,\mathrm{GATE} ext{-}\mathrm{EMITTER}\,\mathrm{VOLTAGE}$ Figure 20. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 600 \text{V}, T_i = 150^{\circ}\text{C})$



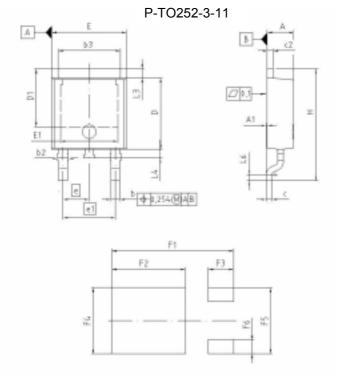
PG-TO220-3-1



Dille	MILLIME	ETERS	INCH	ES
DIM	MIN	MAX	MIN	MAX
Α	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0,085	0.107
ь	0.65	0.86	0,026	0.034
ь1	0.95	1.40	0.037	0.055
ь2	0.95	1.15	0,037	0.045
ь3	0,65	1,15	0,026	0,045
С	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0,335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6.50	8,60	0,256	0,339
e	2.5	4	0.1	00
e1	5.0	18	0.2	00
N		3	3	3
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
øP	3.60	3.89	0.142	0.153
Q	2.60	3.00	0.102	0.118



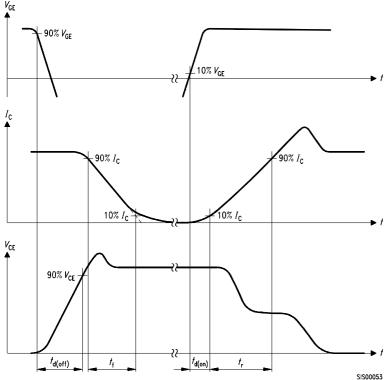




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6.300 6.500 D.248	
2.930 2.300 0.003	
5.700 5.900 0.224	
5.660 5.860 0.222	
1.100 1.300 0.043	







 $p(t) = \begin{bmatrix} \frac{\tau_1}{r_1} & \frac{\tau_2}{r_2} & \frac{\tau_n}{r_n} \\ r_1 & r_2 & r_n \end{bmatrix}$

Figure D. Thermal equivalent circuit

Figure A. Definition of switching times

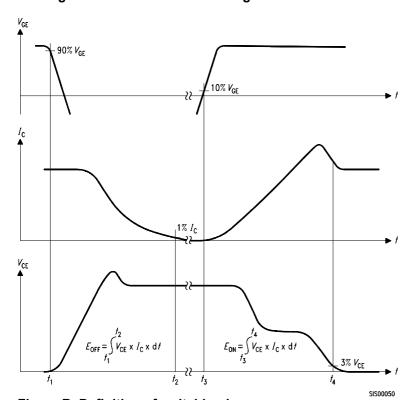


Figure B. Definition of switching losses

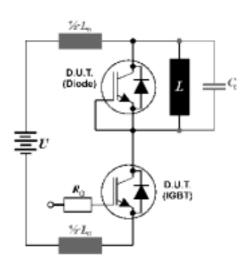


Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH and Stray capacity C_{σ} =250pF.



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